

CeraLink

Material Data Sheet

Product Class	CeraLink B58032I* 04.10.2019							
Date								
IMDS ID if available								
Version	5.03							
Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)	
Active Part	Ceramic	3B	PLZT others*)	98 2	106390-68-5	83.3		
Inner Electrode	Heavy Metal	1C12	Cu	100	7440-50-8	7.9		
Termination	Heavy Metal	1C14	Ni	100	7440-02-0		< 0,01	
	Heavy Metal	1C2	Cr	100	7440-47-3		< 0,01	
	Noble Metal	1D7	Ag	100	7440-22-4		<0,01	
Contacts	Heavy Metal	1C12	Cu	100	7440-50-8	7.8		
	Noble Metal	1D7	Ag	100	7440-22-4	1		
sizes [mm] 14.26 x 13.60 x 9.35 Not part of a Product		material numbers B58032I*						
Contact	Ronner Christoph			Important rema	Important remarks:			
Division	PPD Q QM			1) The decl	The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Traces are			
Address	8530 Deutschlandsberg, AUSTRIA			product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated.				
	Tel: mailto: +43 3462 800 2139 functional.ppd-eqpm.db@tdk-electronics.tdk.com			•	2) This Material Data Sheet contains typical values of the respective products set forth			
*) others: .(not declarab **) typical mass percent	le or prohibited substar			best present kno specifications, ur AFFILIATES HE WHETHER EXP AND VALUES C	herein. We expressly point out that all values and statements contained herein are based on or best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.			
					quirements according to Art. 4 ees in electrical and electronic e		Directive 2011/65/EU	
□ no exemptions; □ Exemption 6 (a): Le □ Exemption 6 (b): Le □ Exemption 7 (c): Le □ Exemption 7 (c)-II: Le □ Exemption 7 (c)-II: Le □ Exemption 7 (c)-III: Le □ Exemption 15: Le □ Exemption 15: Le	ead as an alloying element ead as an alloying element opper alloy containing up to add in high melting tempera ectrical and electronic com ead in dielectric ceramic in ead in dielectric ceramic in	in steel for machining purpos in aluminium containing up to 4 % lead by weight; ture type solder (i.e. lead-ba ponents containing lead in a capacitors for a rated voltage a viable electrical connection	sed alloys containing 85 % by we	ning up to 0,35 % lead by we sight or more lead); ctric ceramic in capacitors, e ner; DC;	.g. piezoelectronic devices, or in a g	lass or ceramic matrix compoun	d;	